

AMP-HDI

TE Internal #: 1-533903-1 PCB Mount Header, Vertical, Board-to-Board, 110 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Natural

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Connectors > PCB Connectors > PCB Headers & Receptacles



EU RoHS Compliance: Not Compliant

EU ELV Compliance: Compliant with Exemptions

PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Features

E

Contact Features

	.21 in
Mating Square Post Dimension	.64 mm[.025 in]
Contact Shape & Form	Four Beam
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Mating Area Plating Material	Gold
Contact Type	Pin
Contact Current Rating (Max)	3 A
Other	
EU RoHS Compliance	Not Compliant
EU ELV Compliance	Compliant with Exemptions
Product Type Features	
PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board

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Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
PCB Mount Orientation	Vertical
Number of Positions	110
Number of Rows	2
Electrical Characteristics	
Insulation Resistance	2 ΜΩ
Body Features	
Primary Product Color	Natural
Termination Features	
Termination Post & Tail Length	4.83 mm[.19 in]
Square Termination Post & Tail Dimension	.64 mm[.025 in]
Termination Method to PCB	Through Hole - Solder

Mechanical Attachment

Mating Alignment Type	Keyed
PCB Mount Retention Type	Solder Tail
PCB Mount Retention	With
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Mating Alignment	Without
Housing Features	
Housing Material	Thermoplastic
Centerline (Pitch)	2.54 mm[.1 in]
Dimensions	
Connector Height	11.73 mm[.462 in]
Usage Conditions	
Housing Temperature Rating	High
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]

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Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	3
Packaging Method	Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024

Halogen Content

Solder Process Capability

Pb (13% in Component)

Article Safe Usage Statements:

SVHC > Threshold:

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.

Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

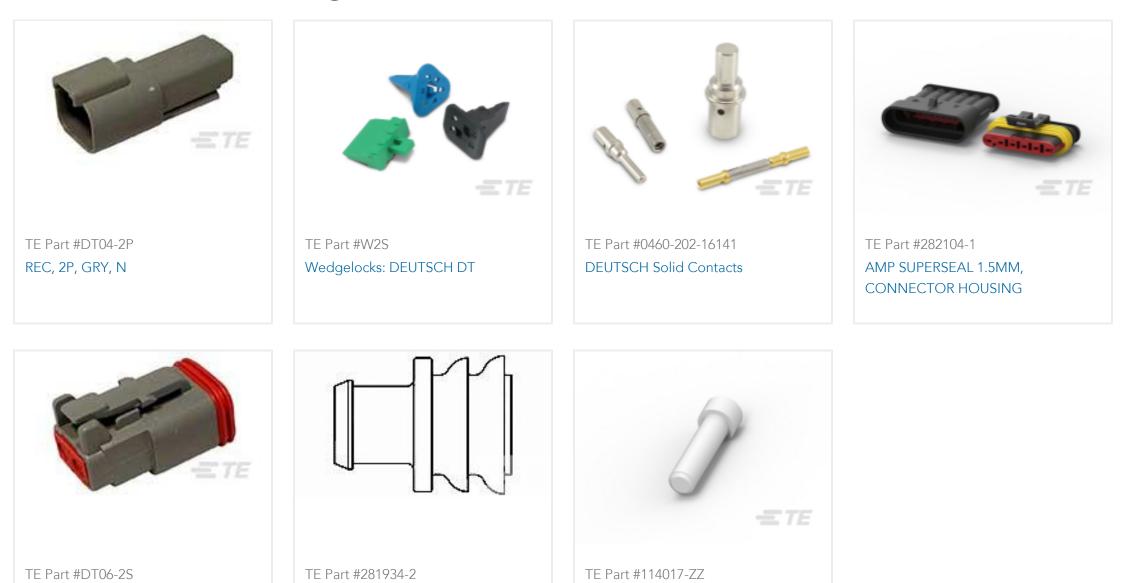
Compatible Parts

PCB Mount Header, Vertical, Board-to-Board, 110 Position, 2.54 mm [.1 in] Centerline, Fully Shrouded, Gold, Through Hole - Solder, Signal, Natural





Customers Also Bought



SINGLE WIRE SEAL

Documents

Product Drawings HDI Pin Assy 2 row 110 pos

1211117,00y 210W 11

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_1-533903-1_G.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_1-533903-1_G.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_1-533903-1_G.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

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Datasheets & Catalog Pages 1-1773957-5_AMP_HDI_BTB_CONNECTORS_EN

English

Product Specifications Application Specification

English

Instruction Sheets Instruction Sheet (U.S.)

English